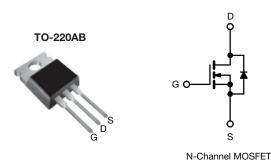


## **Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 5.0 V	0.028		
Q <sub>g</sub> (Max.) (nC)	66			
Q <sub>gs</sub> (nC)	12			
Q <sub>gd</sub> (nC)	43			
Configuration	Single			

#### **FEATURES**

- Dynamic dV/dt rating
- · Logic-level gate drive
- R<sub>DS(on)</sub> specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C operating temperature
- · Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRLZ44PbF
Lead (Pb)-free and halogen-free	IRLZ44PbF-BE3

ABSOLUTE MAXIMUM RATINGS ( $T_C$	= 25 °C, un	less otherwis	se noted)				
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			$V_{DS}$	60	V		
Gate-source voltage			$V_{GS}$	± 10			
Continuous drain current	V <sub>GS</sub> at 5 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	1	50			
	V <sub>GS</sub> at 5 V	T <sub>C</sub> = 100 °C	ID	36	A		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	200			
Linear derating factor			1.0	W/°C			
Single pulse avalanche energy b			E <sub>AS</sub>	400	mJ		
Maximum power dissipation	T <sub>C</sub> = 25 °C		T <sub>C</sub> = 25 °C		$P_{D}$	150	W
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	00			
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300	°C		
Mounting torque	6 20 01	C 00 M0		10	lbf ⋅ in		
	6-32 or M3 screw			1.1	N⋅m		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 179  $\mu$ H,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 51 A (see fig. 12)
- c.  $I_{SD} \le 51$  A,  $dV/dt \le 250$  A/s,  $V_{DD} \le V_{DS}$ ,  $T_{J} \le 175$  °C
- d. 1.6 mm from case
- e. Current limited by the package, (die current = 51 A)



# Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	1.0	

<b>SPECIFICATIONS</b> ( $T_J = 25  ^{\circ}C$ , $t$	ınless otherw	ise noted)					
PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0$	60	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 1 mA	-	0.070	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	<sub>GS</sub> , I <sub>D</sub> = 250 μA	1.0	-	2.0	V
Gate-source leakage	I <sub>GSS</sub>	V	V <sub>GS</sub> = 10 V		-	± 100	nA
Zero gate voltage drain current	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$		$80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	25	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 48 V, V	V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C		-	250	
Drain-source on-state resistance	D	V <sub>GS</sub> = 5.0 V	I <sub>D</sub> = 31 A <sup>b</sup>	-	-	0.028	Ω
	R <sub>DS(on)</sub>	$V_{GS} = 4.0 \text{ V}$	I <sub>D</sub> = 25 A <sup>b</sup>	-	-	0.039	
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 2	5 V, I <sub>D</sub> = 31 A <sup>b</sup>	23	-	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	V	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0 MHz, see fig. 5		3300	-	pF
Output capacitance	C <sub>oss</sub>	V <sub>I</sub>			1200	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1.0			200	-	
Total gate charge	Qg		$V_{GS} = 5.0 \text{ V}$ $I_D = 51 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 b	-	-	66	nC
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 5.0 \text{ V}$		-	-	12	
Gate-drain charge	Q <sub>gd</sub>		g. o and ro	-	-	43	
Turn-on delay time	t <sub>d(on)</sub>		V <sub>DD</sub> = 30 V, I <sub>D</sub> = 51 A,		17	-	- ns
Rise time	t <sub>r</sub>	$V_{DD} = 3$			230	-	
Turn-off delay time	t <sub>d(off)</sub>	$R_g = 4.6 \Omega$ , $R_D = 0.56 \Omega$ , see fig. 10 b		-	42	-	
Fall time	t <sub>f</sub>				110	-	
Internal drain inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal source inductance	L <sub>S</sub>			_	7.5	-	1111
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous source-drain diode current	I <sub>S</sub>	showing the	MOSFET symbol showing the		-	50°	- A
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	200	
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 51 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	2.5	V
Body diode reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 51 A, dl/dt = 100 A/μs b		-	130	180	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	0.84	1.3	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn	on time is negligible (turr	-on is do	minated b	y L <sub>S</sub> and	L <sub>D</sub> )

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %
- c. Current limited by the package, (die current = 51 A)



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

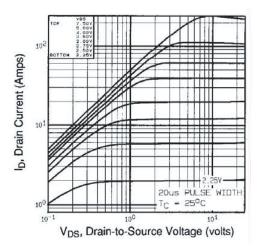


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

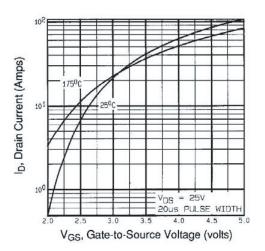


Fig. 3 - Typical Transfer Characteristics

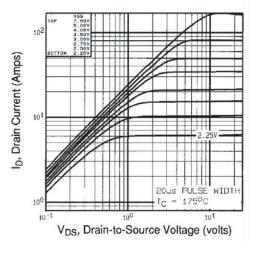


Fig. 2 - Typical Output Characteristics,  $T_C$  = 175 °C

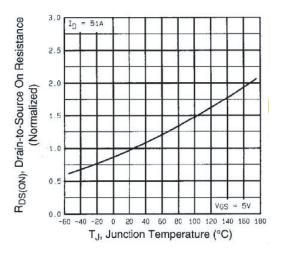


Fig. 4 - Normalized On-Resistance vs. Temperature



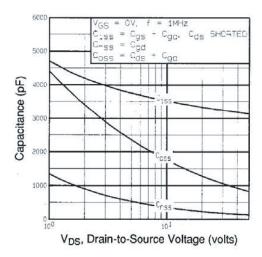


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

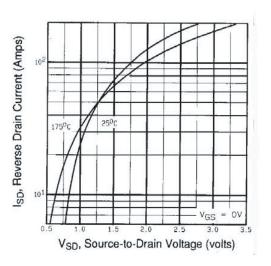


Fig. 7 - Typical Source-Drain Diode Forward Voltage

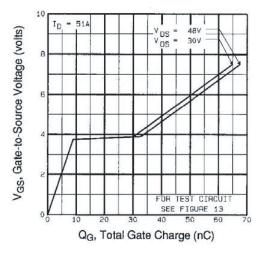


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

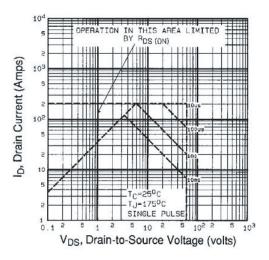


Fig. 8 - Maximum Safe Operating Area



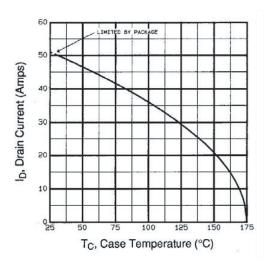


Fig. 9 - Maximum Drain Current vs. Case Temperature

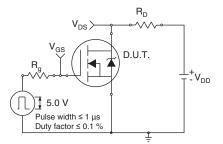


Fig. 10a - Switching Time Test Circuit

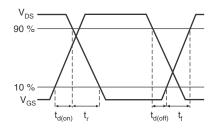


Fig. 10b - Switching Time Waveforms

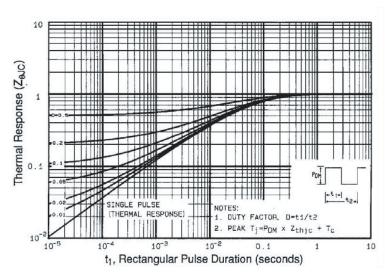
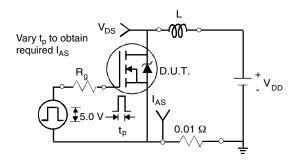


Fig. 10 - Maximum Effective Transient Thermal Impedance, Junction-to-Case







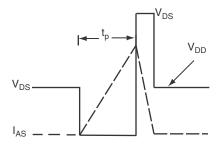


Fig. 12b - Unclamped Inductive Waveforms

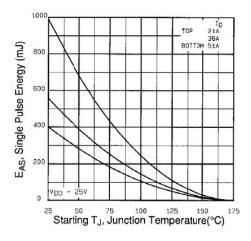


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

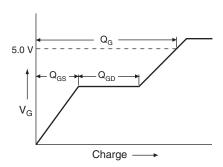


Fig. 13a - Basic Gate Charge Waveform

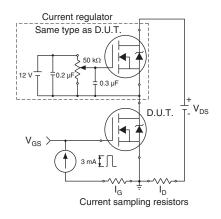
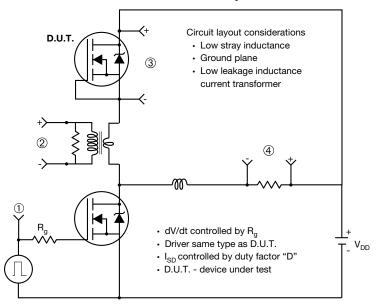


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



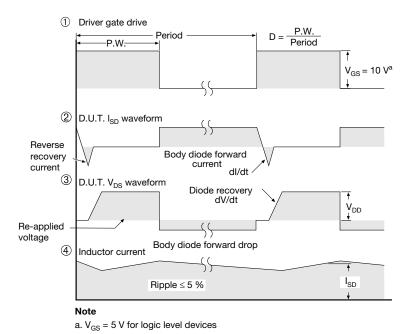


Fig. 11 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?91328">www.vishay.com/ppg?91328</a>.



## **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.